



SamHop Microelectronics Corp.

**STM4605**

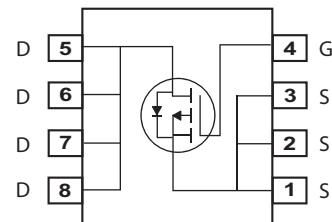
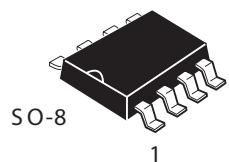
Ver 1.0

P-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY		
VDSS	ID	RDS(ON) (mΩ) Max
-40V	-6A	39 @ VGS=-10V
		58 @ VGS=-4.5V

FEATURES

- Super high dense cell design for low RDS(ON).
- Rugged and reliable.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Units
V_{DS}	Drain-Source Voltage	-40	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current-Continuous ^a	-6	A
	$T_C=25^\circ\text{C}$	-	
	$T_C=70^\circ\text{C}$	-4.8	A
I_{DM}	-Pulsed ^b	-33.5	A
E_{AS}	Single Pulse Avalanche Energy ^d	46	mJ
P_D	Maximum Power Dissipation ^a	2.5	W
	$T_C=25^\circ\text{C}$	-	
	$T_C=70^\circ\text{C}$	1.6	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

$R_\theta JA$	Thermal Resistance, Junction-to-Ambient ^a	50	$^\circ\text{C/W}$
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Details are subject to change without notice.

Jul,27,2010

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-40			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -32V, V_{GS}=0V$			-1	uA
I _{GSS}	Gate-Body Leakage Current	$V_{GS} = \pm 20V, V_{DS}=0V$			± 100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-1.7	-3	V
R _{D(S(ON))}	Drain-Source On-State Resistance	$V_{GS}=-10V, I_D=-6A$		31	39	m ohm
		$V_{GS}=-4.5V, I_D=-4.9A$		43	58	m ohm
g _{Fs}	Forward Transconductance	$V_{DS}=-5V, I_D=-6A$		16.5		S
DYNAMIC CHARACTERISTICS ^c						
C _{iss}	Input Capacitance	$V_{DS}=-20V, V_{GS}=0V$ $f=1.0MHz$		970		pF
C _{oss}	Output Capacitance			120		pF
C _{rss}	Reverse Transfer Capacitance			100		pF
SWITCHING CHARACTERISTICS ^c						
t _{D(ON)}	Turn-On Delay Time	$V_{DD}=-20V$ $I_D=-1A$ $V_{GS}=-10V$ $R_{GEN}=6\text{ ohm}$		14		ns
t _r	Rise Time			16		ns
t _{D(OFF)}	Turn-Off Delay Time			63		ns
t _f	Fall Time			34		ns
Q _g	Total Gate Charge	$V_{DS}=-20V, I_D=-6A, V_{GS}=-10V$		20		nC
		$V_{DS}=-20V, I_D=-6A, V_{GS}=-4.5V$		10		nC
Q _{gs}	Gate-Source Charge	$V_{DS}=-20V, I_D=-6A,$ $V_{GS}=-10V$		1.9		nC
Q _{gd}	Gate-Drain Charge			5.2		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS						
V _{SD}	Diode Forward Voltage ^b	$V_{GS}=0V, I_S=-2A$		-0.8	-1.2	V

Notes

- a.Surface Mounted on FR4 Board,t $\leq 10\text{sec}$.
- b.Pulse Test:Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- c.Guaranteed by design, not subject to production testing.
- d.Starting $T_J=25^\circ C, L=0.5\text{mH}, V_{DD} = 20V$. (See Figure13)

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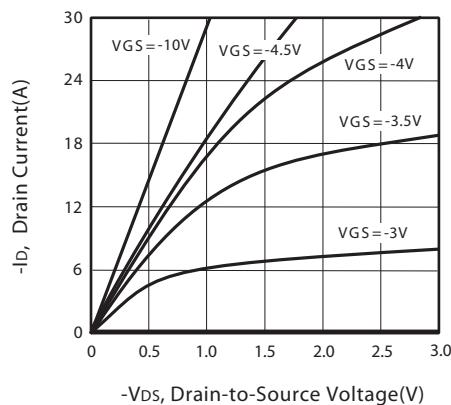


Figure 1. Output Characteristics

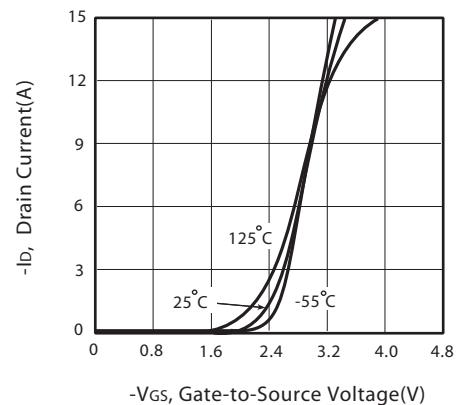


Figure 2. Transfer Characteristics

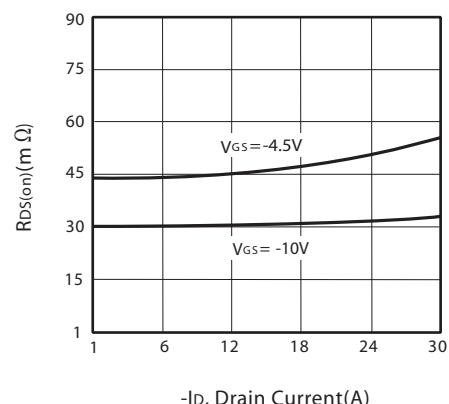


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

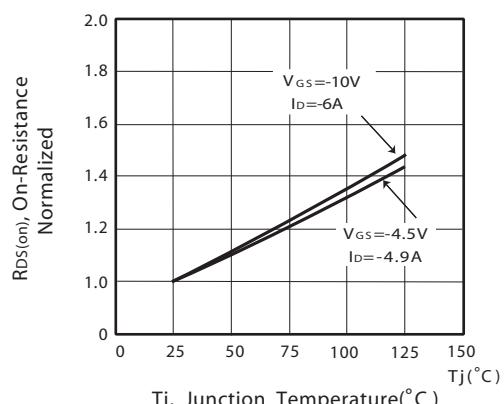


Figure 4. On-Resistance Variation with Drain Current and Temperature

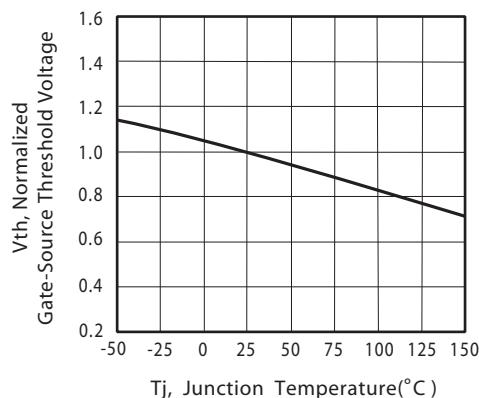


Figure 5. Gate Threshold Variation with Temperature

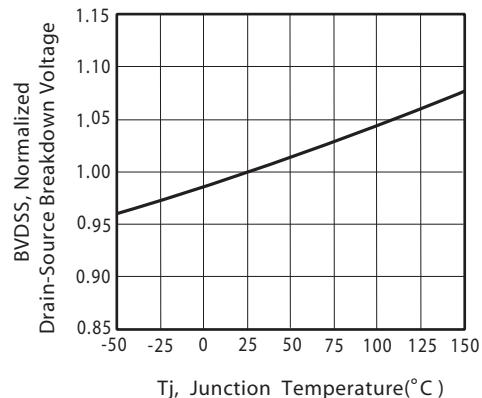


Figure 6. Breakdown Voltage Variation with Temperature

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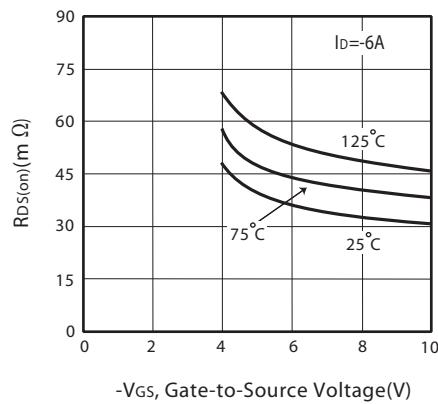


Figure 7. On-Resistance vs. Gate-Source Voltage

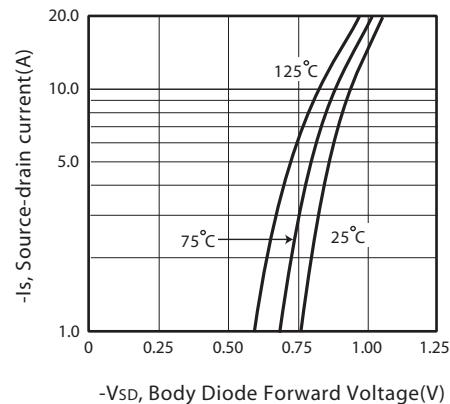


Figure 8. Body Diode Forward Voltage Variation with Source Current

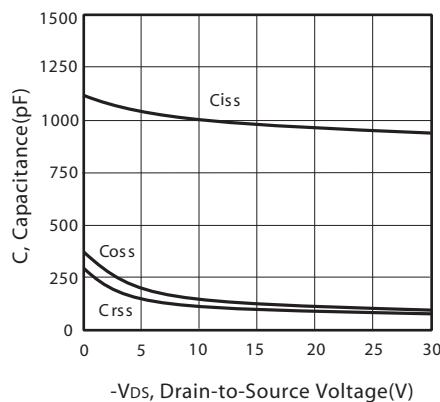


Figure 9. Capacitance

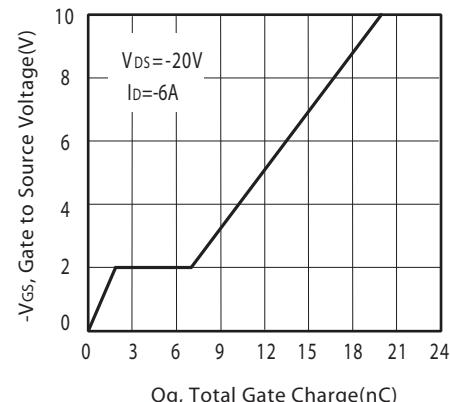


Figure 10. Gate Charge

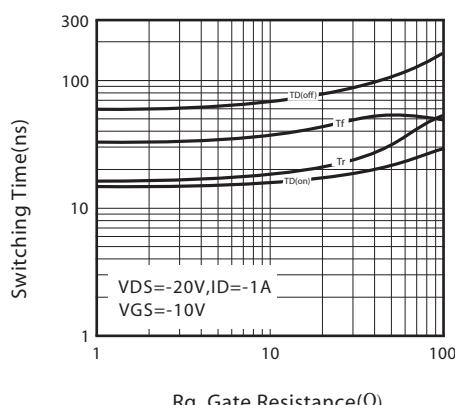


Figure 11. switching characteristics

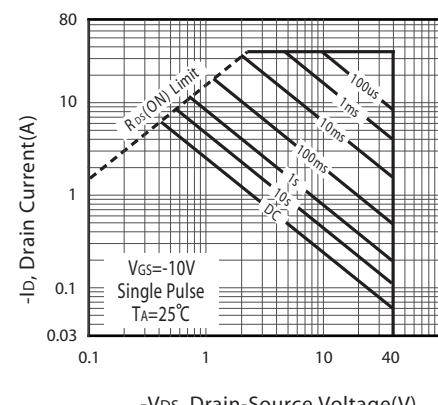
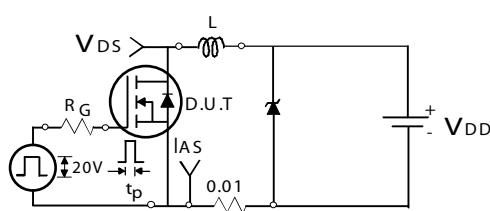


Figure 12. Maximum Safe Operating Area

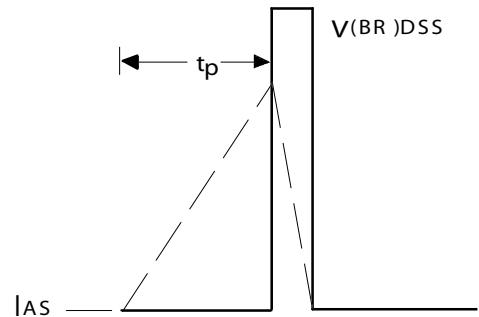
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Unclamped Inductive Test Circuit

Figure 13a.



Unclamped Inductive Waveforms

Figure 13b.

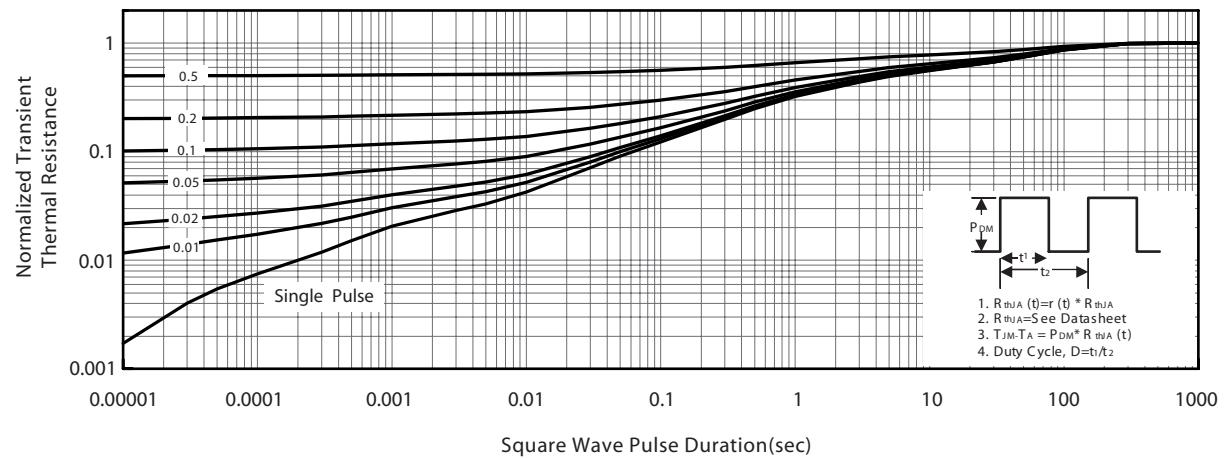
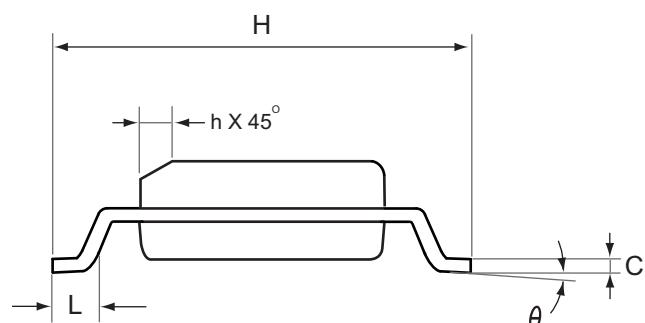
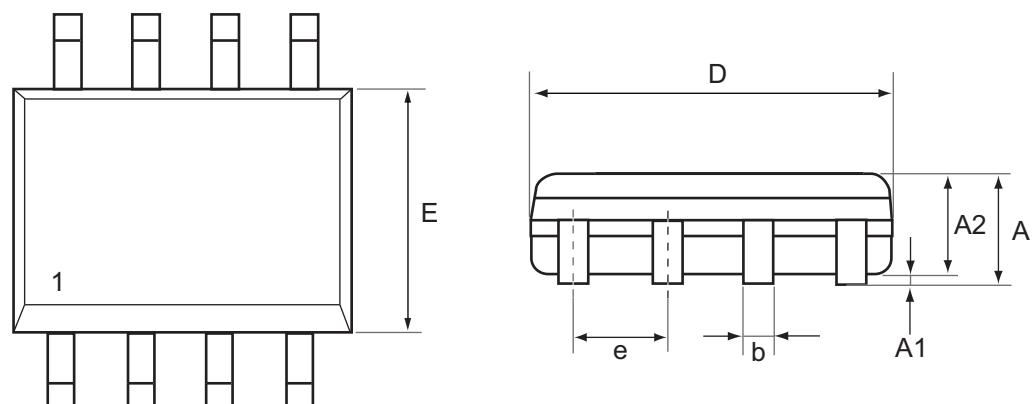


Figure 14. Normalized Thermal Transient Impedance Curve

PACKAGE OUTLINE DIMENSIONS

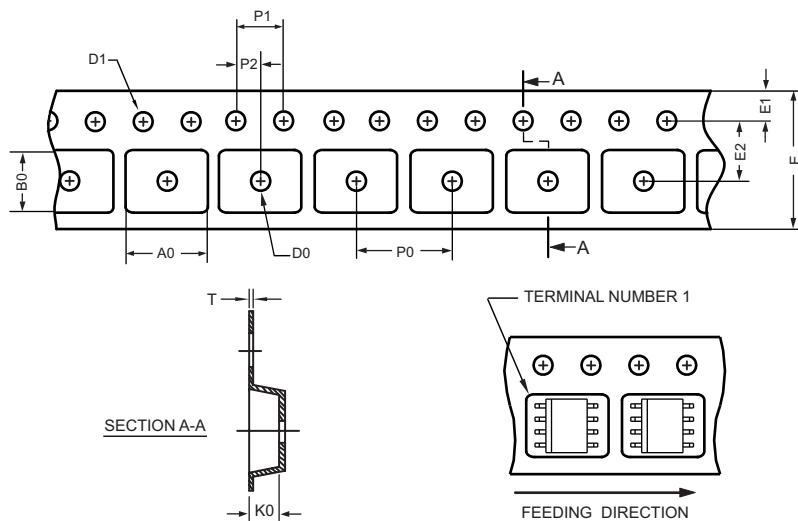
SO-8



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.25	1.63	0.049	0.064
b	0.31	0.51	0.012	0.020
C	0.17	0.25	0.007	0.010
D	4.80	5.00	0.189	0.197
E	3.70	4.00	0.146	0.157
e	1.27 REF.		0.050 BSC	
H	5.80	6.20	0.228	0.244
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°
h	0.25	0.50	0.010	0.020

SO-8 Tape and Reel Data

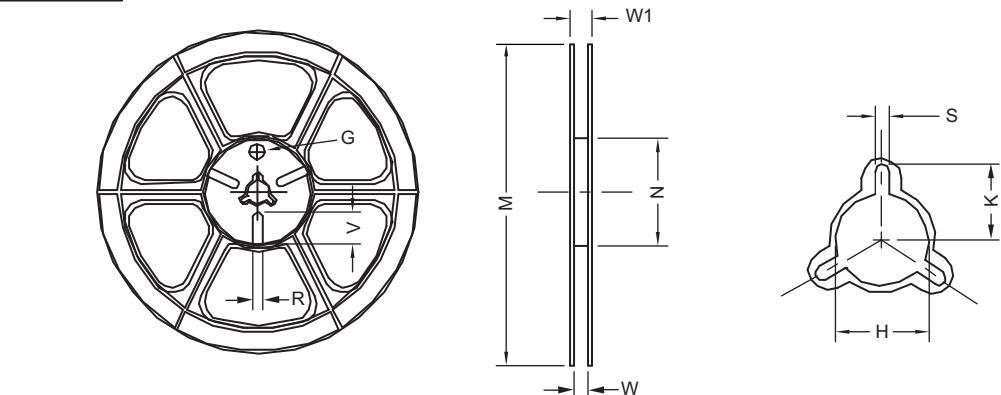
SO-8 Carrier Tape



unit:mm

PACKAGE	A0	B0	K0	D0	D1	E	E1	E2	P0	P1	P2	T
SOP 8N 150mil	6.50 ± 0.15	5.25 ± 0.10	2.10 ± 0.10	$\phi 1.5$ (MIN)	$\phi 1.55$ ± 0.10	12.0 $+0.3$ -0.1	1.75 ± 0.10	5.5 ± 0.10	8.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.10	0.30 ± 0.013

SO-8 Reel



UNIT:mm

TAPE SIZE	REEL SIZE	M	N	W	W1	H	K	S	G	R	V
12 mm	$\phi 330$	330 ± 1	62 ± 1.5	12.4 $+0.2$	16.8 -0.4	$\phi 12.75$ $+0.15$	---	2.0 ± 0.15	---	---	---